1	1.	A method comprising:
2		temporarily flattening a sheet;
3		processing said sheet; and
4		securing said sheet to a second sheet while
<b>E</b>	continuin	to hold said sheet in a flattened configuration.

- 2. The method of claim 1 wherein temporarily flattening the sheet includes placing the sheet in a vacuum chuck and applying a vacuum to flatten the sheet.
- 3. The method of claim 1 wherein processing said sheet includes applying row and column electrodes to said sheet.
- 1 4. The method of claim 3 wherein processing said
  2 sheet includes applying a light emitting material to said
  3 sheet.
- 5. The method of claim 4 wherein applying a light emitting material to said sheet includes applying an organic light emitting material between said row and column electrodes.
- 1 6. The method of claim 1 further including 2 processing said second sheet in a flattened configuration.

- 7. The method of claim 6 including processing said second sheet in a chuck.
- 1 8. The method of claim 7 including processing both
- 2 said first and second sheets in chucks and combining said
- 3 sheets using said chucks.
- 1 9. The method of claim 1 including securing said
- 2 first and second sheets to an integrator plate.
- 1 10. The method of claim 9 including surface mounting
- 2 said first and second sheets.
- 1 11. The method of claim 8 including surface mounting
- 2 said first and second sheets in said chucks.
- 1 12. A method comprising:
- 2 receiving a warped sheet;
- 3 temporarily flattening said sheet for processing;
- 4 processing said flattened, warped sheet; and
- securing said flattened, warped sheet to a planar
- 6 surface.
- 1 13. The method of claim 12 including securing said
- 2 flattened sheet to a second sheet while continuing to hold
- 3 said flattened sheet in a flattened configuration.

- 1 · 14. The method of claim 12 wherein temporarily
- 2 flattening the sheet includes placing the sheet in a vacuum
- 3 chuck and applying a vacuum to flatten the sheet.
- 1 15. The method of claim 12 including securing said
- 2 flattened sheet to a rigid, planar integrating plate.
- 1 16. A method comprising:
- temporarily flattening a ceramic sheet;
- processing a glass panel to define row and column
- 4 electrodes thereon; and
- 5 securing said sheet to said glass panel while
- 6 continuing to hold said sheet in a flattened configuration.
- 1 17. The method of claim 16 including securing said
- 2 sheet and said panel to an integrating plate.
- 1 18. The method of claim 16 wherein temporarily
- 2 flattening the ceramic sheet by placing the sheet in a
- 3 vacuum chuck and applying a vacuum to flatten the sheet.
- 1 19. The method of claim 16 wherein processing said
- 2 panel further includes applying an organic light emitting
- 3 material between said row and column electrodes.

- 1 20. The method of claim 16 further including
- 2 processing both said sheet and said panel in chucks and
- 3 combining said sheet and said panel using said chucks.